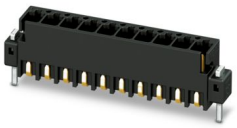
MCV 0,5/ 8-G-2,54 SMDR44C2 - PCB header

1706087

https://www.phoenixcontact.com/us/products/1706087

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The figure shows the 10-position version

PCB headers, nominal cross section: 0.5 mm^2, color: black, nominal current: 6 A, rated voltage (III/2): 160 V, contact surface: Au, contact connection type: Pin, number of potentials: 8, number of rows: 1, number of positions: 8, number of connections: 8, product range: MCV 0,5/.. -G-SMD, pitch: 2.54 mm, mounting: SMD soldering, pin layout: Linear pad geometry, number of solder pins per potential: 1, plug-in system: COMBICON FMC 0,5, Pin connector pattern alignment: Standard, locking: without, mounting method: without, type of packaging: 44 mm wide tape, Fixed coding of the last position, can be combined with the FMC 0,5/...-ST-2,54 C2 connector

Your advantages

- Designed for integration into the SMT soldering process
- Additional solder anchors reduce the mechanical strain on the soldering spots
- Gold-plated contacts ensure transfer quality remains stable over the long term
- Vertical connection enables multi-row arrangement on the PCB
- Supplied in tape-on-reel packing according to IEC 60286-3 for automated mounting

Commercial data

Item number	1706087
Packing unit	315 pc
Minimum order quantity	315 pc
Note	Made to order (non-returnable)
Sales key	AA01
Product key	AAAUAB
GTIN	4046356842518
Weight per piece (including packing)	2.677 g
Weight per piece (excluding packing)	2.22 g
Customs tariff number	85366930
Country of origin	PL

Technical data

Product properties

Product type	PCB headers
Product family	MCV 0,5/..-G-SMD
Product line	COMBICON Connectors XS
Number of positions	8
Pitch	2.54 mm
Number of connections	8
Number of rows	1
Number of potentials	8
Mounting type	without
Pin layout	Linear pad geometry
Solder pins per potential	1

Fitting of components

Partial assembly	No

Electrical properties

Properties

Nominal current I_N	6 A
Nominal voltage U_N	160 V
Contact resistance	2.6 mΩ
Rated voltage (III/3)	32 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	160 V
Rated surge voltage (II/2)	2.5 kV

Mounting

Mounting type	SMD soldering
Pin layout	Linear pad geometry

Processing notes

Process	Reflow soldering
Moisture Sensitive Level	MSL 1
Classification temperature T_c	260 °C
Solder cycles in the reflow	3

Material specifications

Material data - contact

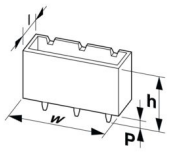
Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201

Contact material	Cu alloy
Surface characteristics	Completely gold-plated
Metal surface contact area (top layer)	Gold (min. 0.25 µm Au)
Metal surface contact area (middle layer)	Nickel (2 µm - 4 µm Ni)
Metal surface soldering area (top layer)	Gold (0.25 µm Au)
Metal surface soldering area (middle layer)	Nickel (2 µm - 4 µm Ni)

Material data - housing

Color (Housing)	black (9005)
Insulating material	LCP
Insulating material group	IIIa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Dimensions

Dimensional drawing	
Pitch	2.54 mm
Width [w]	24.9 mm
Height [h]	4.85 mm
Length [l]	7.1 mm
Pin dimensions	0.64 x 0.64 mm

PCB design

Pad geometry	1.2 x 2.85 mm

Mechanical tests

Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

Polarization and coding

Specification	IEC 60512-13-5:2006-02
Result	Test passed

Contact holder in insert

Specification	IEC 60512-15-1:2008-05
Contact holder in insert Requirements >20 N	Test passed

Insertion and withdrawal forces

Specification	IEC 60512-13-2:2006-02
Result	Test passed
No. of cycles	100
Insertion strength per pos. approx.	2 N
Withdraw strength per pos. approx.	2 N

Electrical tests

Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	16

Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	IIIa
Comparative tracking index (IEC 60112)	CTI 175
Rated insulation voltage (III/3)	32 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	1.5 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.6 mm
Rated insulation voltage (II/2)	160 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	1.6 mm

Environmental and real-life conditions

Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	2.95 kV
Contact resistance R_1	2.6 mΩ
Contact resistance R_2	2.6 mΩ

Insertion/withdrawal cycles	100
Insulation resistance, neighboring positions	> 5 MΩ

Climatic test

Specification	DIN 50018:2013-05
Corrosive stress	1.0 dm^3 SO_2 on 300 dm^3/40 °C/3 cycles
Thermal stress	100 °C/168 h
Power-frequency withstand voltage	1.39 kV

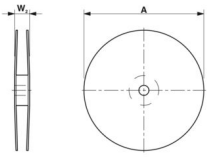
Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 500 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 500 Hz)
Test duration per axis	2 h
Test directions	X-, Y- and Z-axis (pos. and neg.)

Ambient conditions

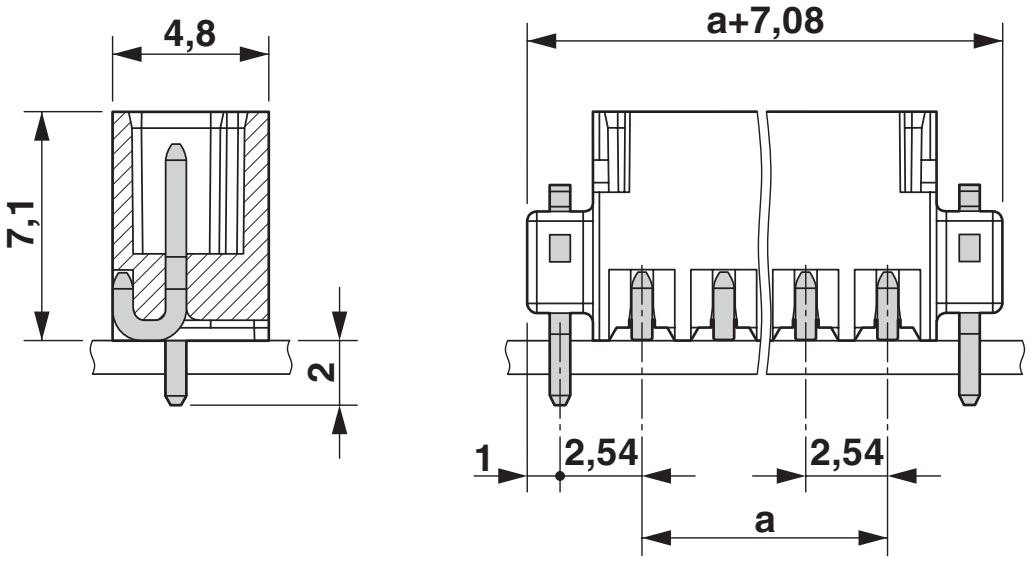
Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)

Packaging specifications

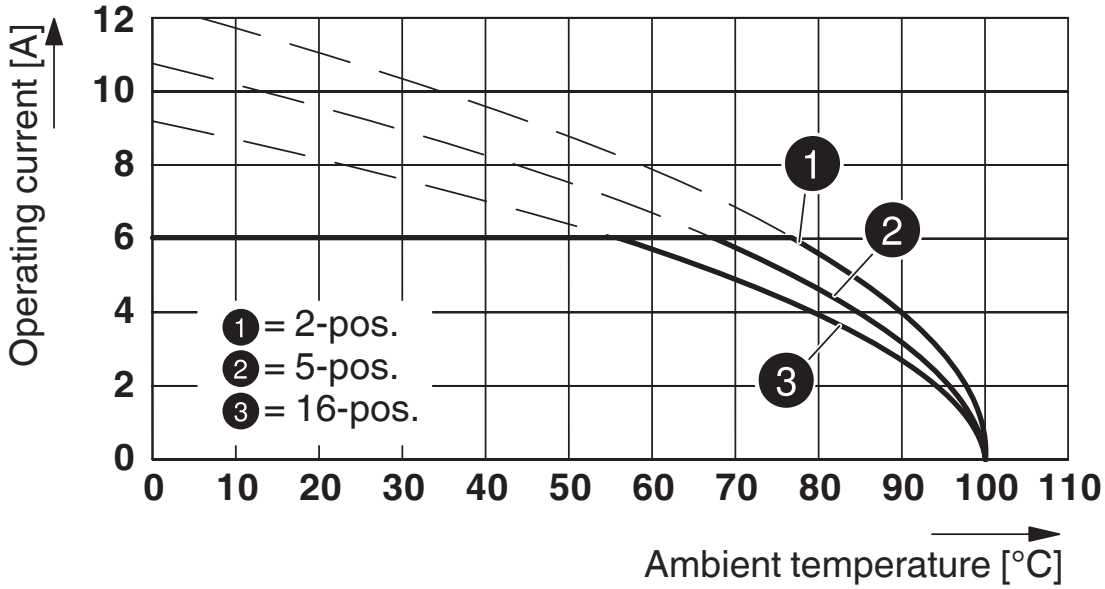
Dimensional drawing	
Type of packaging	44 mm wide tape
[W] tape width	44 mm
[W2] coil overall dimension	≤ 50.4 mm
[A] coil diameter	≤ 330 mm
Outer packaging type	Transparent-Bag

Drawings

Dimensional drawing

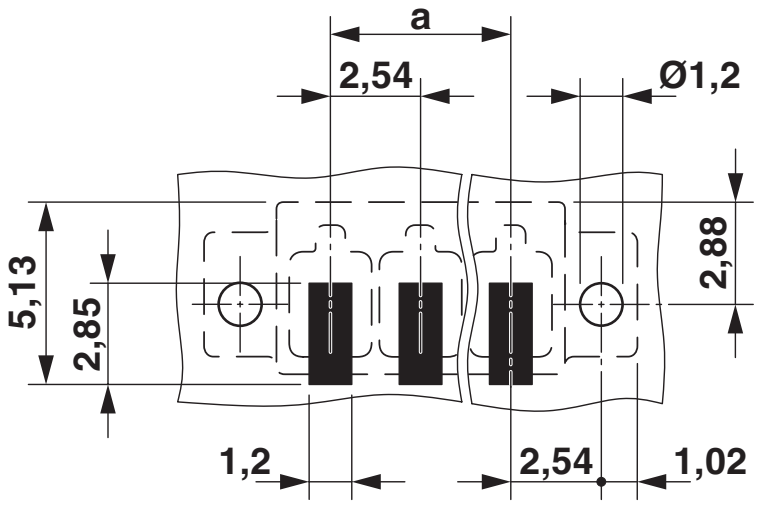


Diagram



Type FMC 0,5/...-ST-2,54 with MCV 0,5/...-G-2,54 SMD R..

Drilling plan/solder pad geometry



Approvals

To download certificates, visit the product detail page: https://www.phoenixcontact.com/us/products/1706087

cULus Recognized
Approval ID: E60425-19920306

	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
B				
Field wiring	150 V	6 A	-	-
C				
Factory wiring	50 V	6 A	-	-

VDE report with production monitoring
Approval ID: 40042258

	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
keine				
	160 V	6 A	-	-

Classifications

ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

ETIM

ETIM 10.0	EC002637

UNSPSC

UNSPSC 21.0	39121400

Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions

China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%

EF3.1 Climate Change

CO2e kg	0.16 kg CO2e

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